## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

[X] is attached hereto [] was filed or	as Application Se	cation of which rial No and was
amended on _	(if a	pplicable)
I hereby state t including the claims, as amended by any ame		contents of the above identified specification
I acknowledge in accordance with Title 37, Code of Federal	the duty to disclose information which Regulations, Section 1.56(a).	is known to me to be material to patentability
application(s) for patent or inventor's certificountry other than the United States of Am	ficate, or 365(a) of any PCT internation terica, listed below and have also identi	J.S.C. 119(a)-(d) or 365 (b) of any foreign nal application which designated at least one field below, by checking the box, any foreign axion having a filing date before that of the
Prior Foreign Application(s): <u>Number</u>	Country	Foreign Filing Date <u>Month/Day/Year</u>
2002-036002	Korea	June 26, 2002
I hereby claim the benefit under 35 U.S.C. 11	9(e) of any United States provisional app	plication(s) listed below.
Application Number(s):	<u>Filing Date (N</u>	<u>Ionth/Day/Year)</u>
designating the United States of America, list not disclosed in the prior United States or PC	ted below and, insofar as the subject ma T international application in the manne formation which is material to patentabil	or 365(c) of any PCT international application teer of each of the claims of this application is a provided by the first paragraph of 35 U.S.C. Lity as defined in 37 CFR 1.56 which became mational filing date of this application.
Prior U. S. Application		Parent Patent Number

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Carol L. Druzbick, Registration No. 40,287; Anthony H. Nourse, Registration No. 46,121; Laura L. Lee, Registration No. 48,752; Rene A. Vazquez, Registration No. 38,647; Donald R. McPhail, Registration No. 35,811; Timothy M. Speer, Registration No. 47,355; Samuel W. Ntiros, Registration No. 39,318; Mark R. Buscher, Registration No. 35,006; and Daniel H. Sherr, Registration No. 46,425, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them. Full name of sole or first inventor: Do-Woo Kang Do Woo Kang Date: Jun. 20, 2003 Inventor's signature: Mailing Address: 201, 207-16, Sanbon 2(i)-dong, Gunpo-si, Gyeonggi-do, Republic of Korea Citizenship: Republic of Korea Residence Address (only if different from mailing address): Full name of sole or first inventor: Hun-Taek Han Hun Joek Hon Inventor's signature: Mailing Address: 201, 104-9, Junggok 4(sa)-dong 100~115, Gwangjin-gu, Seoul, Republic of Korea Citizenship: Residence Address (only if different from mailing address): Full name of sole or first inventor: Hyong-won Kim Myony-won kin Inventor's signature: Mailing Address: 1217-1506, Joo-kong APT, Haan-dong, Gwangmyeong-si. Gyeonggi-do, Republic of Korea Citizenship: Residence Address (only if different from mailing address): Full name of sole or first inventor: Tae-Sook Yoon Free Sook Your Inventor's signature: Mailing Address: 612-10, Yeonsu 2(i)-dong, Yeonsu-gu, Incheon, Republic of Korea Citizenship: Residence Address (only if different from mailing address): Full name of sole or first inventor: Inventor's signature: Date: Mailing Address: Citizenship: Residence Address

(only if different from mailing address):